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## DESCRIPTION

## TITLE

THERMAL TRIP DEVICE

5

AND

CIRCUIT BREAKER USING THE SAME

## TECHNICAL FIELD

The present invention relates to a thermal trip  
10 device and a circuit breaker using the same.

## BACKGROUND ART

A thermal trip device is, for example, a device  
that detects overcurrent in a circuit breaker to trip a  
15 main circuit. Trip characteristic when overcurrent  
flows has its range stipulated by standard such as JIS  
(Japanese Industrial Standard) and products need to  
comply with it. In a thermal trip device, however,  
variation in trip characteristic is inevitable due to  
20 manufacturing variation of constitutional components  
and material variation. Consequently, a structure for  
adjusting the trip characteristic is usually  
incorporated to adjust and inspect the characteristic.

In order to adjust and inspect the trip  
25 characteristic, its characteristic value needs to be  
accurately measured. In the thermal trip device, the  
trip characteristic is often measured by measuring a

time (trip time) from energization initiation to trip completion and an amount of displacement of a bimetal by supplying a predetermined current. Meanwhile, curvature factor of a bimetal is known and therefore  
5 the amount of displacement of the bimetal can be determined by measuring a bimetal temperature. Therefore, the trip characteristic can be figured out by measuring the bimetal temperature.

When measuring the bimetal temperature, a method  
10 of no-contact measurement is preferable in order not to affect on an amount of curvature of the bimetal by measurement. In measurement by a contact thermometer, load is applied to a bimetal from outside via a probe and therefore deflection is generated in the bimetal to  
15 cause change in trip characteristic. As for a method of no-contact temperature measurement, an emission thermometer incorporating an infrared absorption element is commonly used.

However, there is a problem in that a usual  
20 bimetal surface is a metallic luster surface and therefore accurate temperature measurement is difficult. Furthermore, in an electric leakage circuit breaker incorporating an electric leakage detection circuit and a circuit breaker reduced in size, it is difficult to  
25 measure a temperature of the bimetallic surface from outside because of having fewer clearances around the bimetal.

The present invention is implemented to solve such problems, and an object of the present invention is to provide a thermal trip device and a circuit breaker using the same, capable of highly accurately  
5 measuring a bimetal temperature using a no-contact thermometer.

#### DISCLOSURE OF THE INVENTION

According to the present invention, there is  
10 provided a thermal trip device in which a bimetal is heated by overcurrent and performs trip operation of a circuit by curvature of the heated bimetal, wherein at least one part of the surface of the bimetal is made to be black or matte black.

15       Thereby, temperature of the bimetal can be highly accurately measured using a no-contact thermometer.

Furthermore, according to the present invention, the surface of a temperature measurement part of the bimetal is made to be black or matte black.

20       Furthermore, according to the present invention, the temperature measurement part of the bimetal is provided with a bending part bent substantially perpendicular to longitudinal direction, and the surface of the bending part is made to be black or  
25 matte black.

Thereby, even models in which measurement from substantially vertical direction of the bimetallic

surface is difficult, it is possible to stably perform temperature measurement with high accuracy.

Furthermore, according to the present invention, a temperature measurement part of the bimetal is  
5 provided with a bending part bent substantially perpendicular to longitudinal direction.

Thereby, measurement from substantially vertical direction of the bimetal can be made and it is possible to stably perform temperature measurement with high  
10 accuracy.

#### BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a perspective view showing a bimetal part of a thermal trip device according to a first  
15 embodiment of the present invention;

Fig. 2 is a perspective view showing a bimetal part of a thermal trip device according to a second embodiment;

Fig. 3 is a perspective view showing a bimetal  
20 part of a thermal trip device according to a third embodiment;

Fig. 4 is a perspective view showing a bimetal part of a thermal trip device according to a fourth embodiment;

25 Fig. 5 is a plan view showing a material processing step of the bimetal according to the second embodiment;

Fig. 6 is a plan view showing a material processing step of the bimetal according to the third embodiment;

Fig. 7 is a view showing a state where  
5 temperature of the bimetal of the third embodiment is measured using a no-contact thermometer;

Fig. 8 is a view showing a state where temperature of the bimetal of the third embodiment is measured using a no-contact thermometer; and

10 Fig. 9 is a partially cutaway front view showing a structure of a circuit breaker having a thermal trip device.

#### BEST MODE FOR CARRYING OUT THE INVENTION

##### 15 First Embodiment

A circuit breaker is a safety device that interrupts a circuit to prevent accident when overcurrent which is not lower than rating flows. A mechanism that detects overcurrent in the circuit  
20 breaker, is referred to as a trip mechanism; and as one of detecting means thereof, there is a thermal type using a bimetal. This is one, which uses a property that the bimetal curves depending on temperature change. Fig. 9 is a thermal trip mechanism and, more  
25 specifically, is a partially cutaway front view showing a structure of a circuit breaker having a thermal trip device.

Operation when overcurrent which is not lower than rating current flows is as follows.

- (1) Overcurrent flows in a heater 1 or a bimetal 2, thereby increasing temperature of the heater 1 or the  
5 bimetal 2.
- (2) With the temperature increase of the bimetal 2, the bimetal 2 curves.
- (3) An amount of curvature of the bimetal 2 increases to press a trip bar 3.
- 10 (4) A mechanical section 4 actuates to instantaneously interrupt a main circuit 5 (trip).

The range of a time from when the overcurrent flows till the overcurrent trips is stipulated by standard such as JIS and trip time of products must  
15 comply with its range. However, an operational point of the trip mechanism, that is, a position where the bimetal 2 presses the trip bar 3 changes due to accumulation in manufacturing variation such as error in processing and assembling and variation in material  
20 characteristics of each component constituting the trip mechanism; and variation in a time (trip time) from energization initiation to trip completion is generated. Consequently, in order to absorb such manufacturing variation, an adjustment mechanism 6 is provided at a  
25 top end of the bimetal 2 and the trip bar 3 to perform adjustment and inspection work in the assembling step.

In the adjustment and inspection work, trip

characteristic for each workpiece needs to be accurately measured. Usually, the trip characteristic is often measured by measuring the trip time by supplying a predetermined current value and by  
5 measuring an amount of displacement of the bimetal during that time. However, the trip time and the amount of displacement of the bimetal are largely affected by workpiece temperature at energization initiation and measurement environment temperature; and  
10 therefore, the measurement must be performed in a state controlled at a constant temperature or the measurement value must be corrected on the basis of the workpiece temperature and ambient temperature.

Meanwhile, the bimetal is determined by an amount  
15 of curvature (an amount of displacement) on the basis of its temperature and a curvature factor; however, the curvature factor is known and therefore the amount of displacement can be determined by measuring the bimetal temperature. Therefore, the trip characteristic can be  
20 measured by measuring the bimetal temperature.

In the measurement of the bimetal temperature, a no-contact emission thermometer is commonly used. This is because that when a contact thermometer is used, deflection of the bimetal is generated due to contact  
25 load of a probe to change trip characteristic, so that accurate trip characteristic cannot be measured.

The no-contact thermometer measures an object's

temperature by detecting an amount of emission energy of infrared rays emitted from the object. An amount of infrared radiation differs depending on a material and a surface state; and an amount of emitted infrared  
5 energy (emissivity) is different even at the same temperature. The no-contact thermometer calculates temperature on the basis of an ideal black body (theoretical body of emissivity 100%) and an object other than that must be corrected in accordance with  
10 each emissivity.

The emissivity can be usually obtained on a trial basis. Since it is difficult to determine emissivity of a measured object in a short time, the emissivity cannot be determined for each workpiece in the mass  
15 production step. Therefore, in the case where the emissivity of the bimetal varies, its variation becomes variation of temperature measurement. Further, the bimetallic surface is usually a metallic luster surface and therefore infrared rays emitted from other heat  
20 source in the vicinity of the bimetal such as a heater or the like are easy to be reflected on the bimetallic surface. If the reflected light enters into an emission thermometer, it causes measurement error.

Furthermore, temperature measurement is possible  
25 by correcting depending on the emissivity even in the case where the emissivity is low; however, an absolute amount of the infrared rays reduces and therefore noise



components in measuring increase to cause accuracy degradation in the temperature measurement.

Consequently, it is preferable that the emissivity is high and constant for highly accurate temperature  
5 measurement.

Consequently, in the present invention, the surface serving as a temperature measurement part of the bimetal 2 is made to be black, preferably matte black 7 (refer to Fig. 1), thereby increasing the  
10 emissivity and being constant. This makes even a different workpiece a constant high emissivity and therefore the bimetal temperature can be highly accurately and stably measured. Furthermore, reflection from other heat source can be suppressed by  
15 a matte coating and measurement error can be reduced. Fig. 1 is a perspective view showing a bimetal part of a thermal trip device according to a first embodiment of the present invention. In order to make black, for example, there is a method such as coating and etching.  
20 In order to make matte black, matte black coating may be used. Furthermore, it may make matte black by oxidizing together with etching. In this case, as for etching solution, for example, sodium hydroxide solution and phosphate solution are used when the  
25 bimetal 2 is an iron group material; and, for example, acid aqueous solution containing selenium is used when it is a copper group material.

## Second Embodiment

In order to highly accurately measure a bimetal temperature; a temperature measurement position in a  
5 bimetal, that is, a temperature measurement part 8 (refer to Fig. 2) needs to be fixed. This is because a temperature distribution exists in a bimetal 2, for it is difficult to uniformly heat the entire bimetal in heating the bimetal 2 by a heater. Therefore,  
10 blackening process of the surface of the bimetal 2 described in the first embodiment may be applied to the temperature measurement part. Fig. 2 is a perspective view showing a bimetal part of a thermal trip device according to a second embodiment.

15 Usually, the bimetal 2 for use in a circuit breaker is manufactured by press working from an elongate bimetallic material 9 (refer to Fig. 5). Therefore, only a part to be the temperature measurement part in a step of the material 9 is made to  
20 be black, preferably matte black 7; and by performing press working on it, a bimetallic strip in which only a necessary part is blackened can be obtained. Fig. 5 is a plan view showing a material processing step of the bimetal according to the second embodiment. Blackening  
25 process performed in a state of the bimetallic strip is more simplified and reduced in processing cost than blackening process performed in a state of the material

in block. Furthermore, minimizing the processing part as in the second embodiment can further reduce processing cost.

#### 5 Third Embodiment

An example where two black parts are provided on a bimetallic material 9 is shown in Fig. 6. There is a bimetal shape that gradually narrows toward a top end; and in this case, orientation of bimetallic strips is  
10 alternatively combined and press worked, whereby yield of the material 9 can be increased. The bimetallic material 9 drawn out from a rolled material is provided with two black parts and press worked as shown in the drawing. A perspective view of a principal part of a  
15 thermal trip device using the bimetal formed in a third embodiment is shown in Fig. 3.

#### Fourth Embodiment

In order to measure a bimetal temperature using a  
20 no-contact thermometer, the thermometer is installed substantially perpendicular to a temperature measurement part 8 of the bimetal and no obstacle which blocks infrared rays needs to be existed therebetween. Fig. 7 is a view showing a state where the bimetal 2 of  
25 the third embodiment is measured using a no-contact thermometer 10.

However, for example, an electric leakage

detection section is incorporated in an electric leakage circuit breaker adjacent to the bimetal and there are many cases where the above-mentioned space cannot be secured. Furthermore, in also a circuit  
5 breaker, points that can measure a bimetal temperature are limited due to downsizing of the product and there is a case where it is impossible to measure ideal temperature measurement points on the bimetal. A fourth embodiment is possible to perform temperature  
10 measurement at desired points even in such a case.

A perspective view of a bimetal part of a thermal trip device according to a fourth embodiment is shown in Fig. 4. A bending part 11 is provided at a point serving as a temperature measurement part 8 of the  
15 bimetal.

As shown in Fig. 8, a bending part 11 is provided substantially perpendicular to longitudinal direction of the bimetal 2 at the temperature measurement part 8 of the bimetal so as to measure temperature from the  
20 longitudinal direction of the bimetal. In the thermal trip device, a measurable space is often provided in the longitudinal direction of the bimetal 2 because it is necessary to have a space for bending the bimetal 2 and to adjust trip characteristic. However, it is very  
25 difficult to measure temperature, because in a conventional bimetal, only a measurable space as much as thickness is provided from this direction.

Consequently, bending process is applied to a part which is the temperature measurement part 8 of the bimetal 2 to provide a bending part 11 so as to secure an area necessary for temperature measurement, whereby  
5 it is possible to measure temperature from upper side by a no-contact thermometer 10 parallel to a longitudinal direction of the bimetal 2, as shown in Fig. 8. It is possible to measure temperature at any location of the bimetal by changing a position to which  
10 the bending process is applied.

Further, if a part where temperature measurement is performed at the surface of the bending part is made to be black, preferably matte black, after the bending process or before the bending process; it is possible  
15 to further highly accurately measure the bimetal temperature.

#### INDUSTRIAL APPLICABILITY

As described above, a thermal trip device  
20 according to the present invention become possible to highly accurately measure bimetal temperature using a no-contact thermometer and therefore an amount of displacement of the bimetal can be precisely determined; this device is suitably applied to a  
25 circuit breaker; and characteristic of the circuit breaker can be easily stabled.